

TITLE OF THE INVENTION

ELECTRODE FOR ELECTRON GUN, METHOD OF MANUFACTURING  
ELECTRODE FOR ELECTRON GUN, AND ELECTRON GUN ASSEMBLY

CROSS-REFERENCE TO RELATED APPLICATIONS

5           This application is based upon and claims the  
benefit of priority from the prior Japanese Patent  
Application No. 2002-236052, filed August 13, 2002, the  
entire contents of which are incorporated herein by  
reference.

10                           BACKGROUND OF THE INVENTION

1. Field of the Invention

          The present invention relates generally to  
an electrode for an electron gun, a method of  
manufacturing an electrode for an electron gun, and  
15   an electron gun assembly. In particular, this  
invention relates to an electrode for an electron gun,  
which is applicable as a first grid electrode of  
an electron gun assembly, a method of manufacturing  
the electrode for the electron gun, and an electron gun  
20   assembly including the electrode for the electron gun.

2. Description of the Related Art

          In the prior art, as described in Jpn. Pat. Appln.  
KOKAI Publication No. 64-43952, for instance,  
an electron gun assembly applied to a cathode-ray  
25   tube is configured to include a cathode that emits  
electrons, and a plurality of electron gun electrodes  
disposed coaxial with the cathode.

In this type of electron gun assembly, while it is being operated, barium oxide (BaO), which is an electron emission substance of the cathode, is reduced with the emission of electrons. As a result, barium (Ba) is evaporated from the cathode. Most of the evaporated barium (Ba) tends to easily deposit on a first grid electrode, which is one of a plurality of electron gun electrodes and is disposed near the cathode.

In an electron gun assembly described in Jpn. Pat. Appln. KOKAI Publication No. 64-43952, it is intended to positively remove the deposited barium (Ba) by a reduction action of a metal coat film formed on a surface of the first grid electrode. However, the metal coat film is easily oxidized in the manufacturing process of the cathode-ray tube and thus the metal coat film cannot fully function. Consequently, a barium film may easily deposit on the surface of the first grid electrode.

If a barium (Ba) film deposits on the surface of the first grid electrode with the passing of operation time, as mentioned above, the barium film may possibly remove and drop from the first grid electrode due to various factors such as vibration. The removed barium film may short-circuit the first grid electrode and the cathode, or the first grid electrode and the second grid electrode. Hence, the performance of the electron

gun assembly may deteriorate, or a fault may occur in the electron gun assembly, which leads to degradation in reliability.

#### BRIEF SUMMARY OF THE INVENTION

5           The present invention has been made to solve the above problem, and the object of the invention is to provide an electrode for an electron gun, a method of manufacturing an electrode for an electron gun, and an electron gun assembly, which have an improved  
10           reliability.

          According to a first aspect of the invention, there is provided an electrode for an electron gun, which is a first grid electrode located on a cathode side, the first grid electrode being one of a plurality  
15           of electrodes for the electron gun used in an electrode gun assembly, wherein a surface of the first grid electrode is formed to be a rough surface having a higher degree of surface roughness than a surface of a second grid electrode located adjacent to the first  
20           grid electrode.

          According to a second aspect of the invention, there is provided a method of manufacturing an electrode for an electron gun, which is a first grid electrode located on a cathode side, the first grid  
25           electrode being one of a plurality of electrodes for the electron gun used in an electrode gun assembly, wherein a surface of the first grid electrode is formed

to be a rough surface having a higher degree of surface roughness than a surface of a second grid electrode located adjacent to the first grid electrode.

According to a third aspect of the invention,  
5 there is provided an electron gun assembly having an electron beam generating section that generates an electron beam, wherein the electron beam generating section comprises a cathode, a first grid electrode located on the cathode side, and a second grid  
10 electrode located adjacent to the first grid electrode, and a surface of the first grid electrode is formed to be a rough surface having a higher degree of surface roughness than a surface of the second grid electrode.

Additional objects and advantages of the invention  
15 will be set forth in the description which follows, and in part will be obvious from the description, or may be learned by practice of the invention. The objects and advantages of the invention may be realized and obtained by means of the instrumentalities and  
20 combinations particularly pointed out hereinafter.

#### BRIEF DESCRIPTION OF THE SEVERAL VIEWS OF THE DRAWING

The accompanying drawings, which are incorporated in and constitute a part of the specification, illustrate presently preferred embodiments of the  
25 invention, and together with the general description given above and the detailed description of the preferred embodiments given below, serve to explain the

principles of the invention.

FIG. 1 is a partial cross-sectional view schematically showing the structure of an electron gun assembly according to an embodiment of the present invention;

FIG. 2 is a perspective view schematically showing the structure of a first grid electrode shown in FIG. 1, the first grid electrode being viewed from the cathode side;

FIG. 3 is a perspective view schematically showing the structure of the first grid electrode shown in FIG. 1, the first grid electrode being viewed from the second grid electrode side (the side opposite to the cathode); and

FIG. 4 is a cross-sectional view schematically showing the structure of the first grid electrode shown in FIG. 1.

#### DETAILED DESCRIPTION OF THE INVENTION

Embodiments of an electrode for an electron gun, a method of manufacturing an electrode for an electron gun, and an electron gun assembly, according to the present invention, will now be described in detail with reference to the accompanying drawings.

As is shown in FIG. 1, an electron gun assembly 11 that is applicable to a cathode-ray tube comprises a cathode 12 that can emit electrons, a plurality of electron gun electrodes 13 disposed in succession on

the same axis at regular intervals, relative to the cathode 12, and a pair of bead glasses 14 that hold and integrally fix implant portions of the cathode 12 and the plural electron gun electrodes 13.

5           The cathode 12 is formed such that void portions of porous tungsten with a void ratio of, e.g. about 20% are impregnated, in a high-temperature hydrogen atmosphere, with molten electron emission substances of barium oxide (BaO), calcium oxide (CaO) and aluminum  
10 oxide ( $\text{Al}_2\text{O}_3$ ). The mole composition ratio of the electron emission substances of the cathode 12 is  $\text{BaO}:\text{CaO}:\text{Al}_2\text{O}_3 = 4:1:1$ . An iridium (Ir) film having a thickness of  $0.2 \mu\text{m}$  is coated on the surface of the cathode 12 with this structure.

15           The plural electron gun electrodes 13 comprise a first grid electrode G1, a second grid electrode G2, a third grid electrode G3, a fourth grid electrode G4, a fifth grid electrode G5 and a sixth grid electrode G6, which are arranged in the named order from the  
20 cathode 12 side. The bead glass 14 is formed of an insulating material. Each bead glass 14 is a rod extending in the axial direction. Implant portions provided on the cathode 12 and on each electron gun electrode 13 are embedded in the pair of bead  
25 glasses 14.

          The electron gun assembly 11 with the above structure includes an electron beam generating section

and an electron lens section that are composed of the electron gun electrodes, to which predetermined voltages are applied. For example, the cathode 12, first grid electrode G1 and second grid electrode G2 constitute the electron beam generating section that generates electron beams.

As is shown in FIGS. 2 to 4, the electron gun electrode applicable as the first grid electrode G1 is formed by pressing a thin material metal plate 20 with a thickness of about 0.15 mm to 0.25 mm, which is formed of, e.g. stainless steel, Kovar alloy, or nickel-iron alloy. The electron gun electrode G1 has three beam passage portions 21 at locations corresponding to positions where red, blue and green electron beams travel in order to reproduce a color image.

Each beam passage portion 21 has a coin portion 22 and a bead portion 23. The coin portion 22 has a flat circular shape on a first major surface 20a of the metal plate 20, which faces the cathode 12. The bead portion 23 has an annular shape surrounding the coin portion 22. The bead portion 23 has a ridge-like shape on the first major surface 20a, and projects toward the cathode 12.

The coin portion 22 has a circular recess portion 24 in a second major surface 20b of the metal plate 20, which faces the second grid electrode G2. The recess portion 24 is formed by thinning the material metal

plate 20. Specifically, the recess portion 24 has, as  
a bottom portion, a thin circular portion 25 with  
a thickness of about 0.06 mm to 0.08 mm. The thin  
circular portion 25 has a beam passage hole 26 formed  
5 at a substantially central portion thereof, which  
permits passage of the associated electron beam.

The surface of the first grid electrode G1 is  
formed as a rough surface 27 having a higher surface  
roughness than, at least, the surface of the second  
10 grid electrode G2 that is adjacent to the first grid  
electrode G1. The rough surface 27 is formed on the  
entire first grid electrode G1 or on at least  
a peripheral portion of the beam passage hole 26.

The peripheral portion of the beam passage hole  
15 26, in this context, includes an inner peripheral  
surface of the beam passage hole 26, the first major  
surface 20a facing the cathode 12, and the second major  
surface 20b located on the side opposite to the cathode  
12 side. The reason why at least the peripheral  
20 portion of the beam passage hole 26 is formed of the  
rough surface 27 is that evaporated matter, which is  
evaporated from the cathode 12 and deposits on the  
first grid electrode G1, concentrates at the peripheral  
portion of the beam passage hole 26.

25 It is preferable that the surface roughness  $R_z$   
of the rough surface 27 be in a range of 0.2  $\mu\text{m}$  to  
1.5  $\mu\text{m}$ . If the surface roughness  $R_z$  is less than



0.2  $\mu\text{m}$ , the degree of unevenness of the surface of the metal plate 20 is too low to attain a sufficient strength of bonding with evaporated matter. If the surface roughness  $R_z$  is greater than 1.5  $\mu\text{m}$ , the  
5 degree of unevenness of the surface of the metal plate 20 is high enough to attain a sufficient strength of bonding with evaporated matter, but the degree of unevenness is so high that unnecessary electron emission may easily be induced by the potential of the  
10 first grid electrode G1. Consequently, even after the cathode-ray tube is switched off, the screen is not completely turned off and the screen would remain partly luminous. Besides, the rough surface 27 looks as if it were scarred, which is not preferable in terms  
15 of external appearance.

The rough surface 27 is formed by a surface reforming process that reforms the surface condition of the material metal plate 20. The surface reforming process is not limited if it can set the surface  
20 roughness of a desired location on the metal plate 20 within the above-mentioned range. Examples of the surface reforming process include etching by chemical polishing using an acid, etching by reverse-sputtering in a film forming unit, and an air-baking process that  
25 oxidizes the surface of the metal plate 20 by baking it in air. These processes roughen the surface of the metal plate 20 by forming air bubbles thereon.

According to the cathode-ray tube including the electron gun assembly with the above structure, while it is being operated, barium oxide ( $\text{BaO}$ ), which is an electron emission substance of the cathode 12, is reduced with the emission of electrons. As a result, barium ( $\text{Ba}$ ) is evaporated from the cathode 12. Most of the evaporated barium ( $\text{Ba}$ ) deposits on the first grid electrode G1, which is one of the electron gun electrodes 13 and is disposed near the cathode, and it particularly deposits on the peripheral portion of the beam passage hole 26. The barium ( $\text{Ba}$ ), or the evaporated matter, deposits in the form of a film on the periphery of the beam passage hole 26 with the passing of operation time.

At least the peripheral portion of the beam passage hole 26 of the first grid electrode G1 is formed as the rough surface 27. The rough surface 27 has a high degree of unevenness and has an increased contact area with the deposited barium film. In addition, since the uneven area of the rough surface 27 serves as "wedge", the strength of bonding between the rough surface 27 of first grid electrode G1 and the deposited barium film is increased. Hence, even if various factors such as vibration occur, it is less possible that the deposited barium film removes and drops from the first grid electrode G1. Accordingly, it is possible to suppress the occurrence of

short-circuit due to the removed barium film between  
the cathode 12 and the first grid electrode G1 or  
between the first grid electrode G1 and the second grid  
electrode G2. Therefore, it is possible to prevent  
5 deterioration in the performance of the electron gun  
assembly, or a fault occurring in the electron gun  
assembly. The reliability of the electron gun assembly  
is thus enhanced.

The surface roughness  $R_z$  of the rough surface 27  
10 is set in the range of  $0.2\ \mu\text{m}$  to  $1.5\ \mu\text{m}$ . Thereby, it  
is possible to attain a sufficient strength of bonding  
between the rough surface 27 and the barium film  
deposited on the rough surface 27, and to suppress  
unnecessary electron emission due to an excessively  
15 high degree of surface roughness. The surface  
roughness can be properly set to achieve these two  
features.

The rough surface 27 is formed by reforming the  
surface condition of the material metal plate 20.  
20 It is thus possible to easily create the uneven shape  
that can achieve the sufficient strength of bonding  
with the deposited barium film.

There is another method of forming the rough  
surface 27 on the first grid electrode G1, wherein the  
25 surface of the material (metal plate) 20 is provided  
with unevenness (roughness) by rolling the material 20  
with a roller with unevenness. However, since the coin

portion 22 and thin (recess) portion 24 are formed by pressing the material 20, the surface unevenness may easily be flattened. Thus, the rough surface 27 can be formed more exactly by the method in which the surface reforming process is performed after pressing  
5 the material 20 into the shape of the first grid electrode G1.

As has been described above, according to the present invention, the surface of one of the plural  
10 electron gun electrodes, which is located closest to the cathode, that is, the surface of the first grid electrode, is formed to have a rough surface with a higher surface roughness than the surface of the electron gun electrode located adjacent to the first  
15 grid electrode, that is, the second grid electrode. Therefore, the strength of bonding between the rough surface of the first grid electrode and the deposit matter, which is evaporated from the cathode and deposits on the rough surface of the first grid  
20 electrode, can be increased, and the possibility of removal of the deposit matter can be decreased. Accordingly, deterioration of the performance of the electron gun assembly and the occurrence of fault of the electron gun assembly can be prevented, and the  
25 reliability is enhanced.

Additional advantages and modifications will readily occur to those skilled in the art. Therefore,

the invention in its broader aspects is not limited to  
the specific details and representative embodiments  
shown and described herein. Accordingly, various  
modifications may be made without departing from the  
5 spirit or scope of the general inventive concept as  
defined by the appended claims and their equivalents.